



GUANGDONGTONGJIA OPTOELECTRONICS TECHNOLOGY CO., LTD

承認書

Specification For Approval

Customer: (客戶)

Description: (產品描述)

SMD3224灯珠带透镜红光

Part number: (產品型號)

TJ-S3224SW2T3ALC2R-A5

Date: (日期)

Approved By: (客戶承認)

Prepared By: (我司承認)

Approval	Check	Design	Sales

核准

審核

製作

業務

Customer Service Hotline: **400-676-8616**

TEL: 0769-8662 5999 0769-8200 2226

E-MAIL : dg@togialed.com

FAX: 0769-8200 2227

WEB: www.togialed.com

Features

3.2mm x 2.4mm SMD LED, 2.4 mm thickness

Low power consumption

Wide view angle

Package: 2000pcs/reel

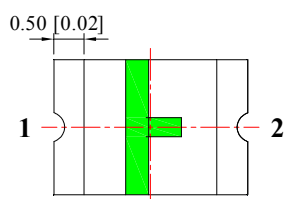
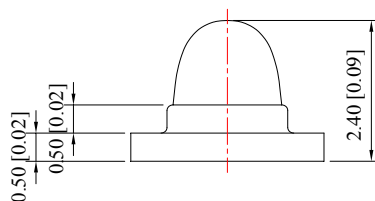
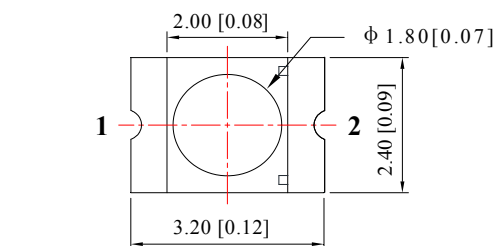
RoHS Compliant

Applications

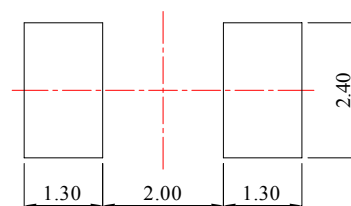
Ideal for back light and indicator

Various colors and lens types available

Package outlines



Recommend Pad Layout



Part No.	Emitted color	Dice	Lens color
TJ-S3224SW2T3ALC2R-A5	Red	AlGaInP	Water transparent

Notes:

All dimensions are in millimeters (inches);

Tolerances are $\pm 0.1\text{mm}$ (0.004inch) unless otherwise noted.

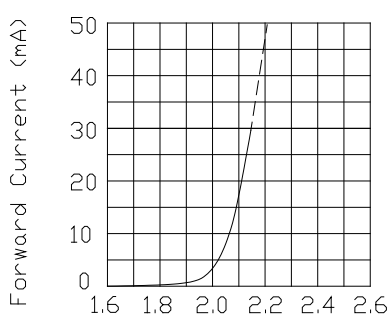
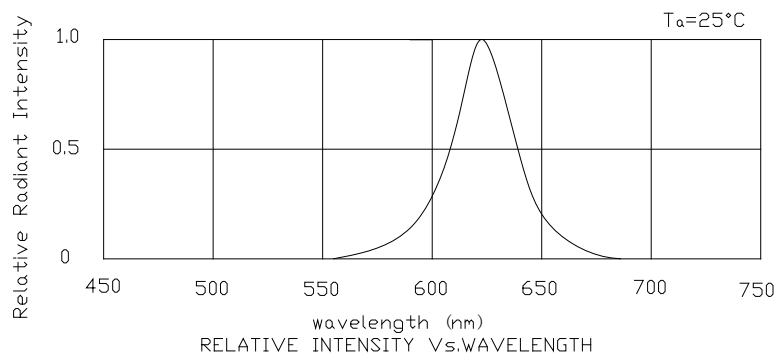
Absolute Maximum Ratings (TA=25 °C)

Parameter	Symbol	Value	Unit
Forward current	If	30	mA
Reverse voltage	Vr	5	V
Power dissipation	Pd	72	mW
Operating temperature	Top	-40 ~+80	°C
Storage temperature	Tstg	-40 ~+85	°C
Peak pulsing current (1/8 duty f=1kHz)	Ifp	125	mA

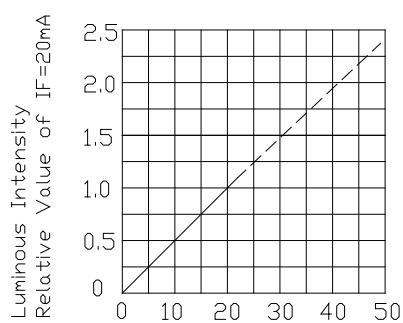
Electro-Optical Characteristics (TA=25 °C)

Parameter	Test Condition	Symbol	Value			Unit
			Min	Typ	Max	
Wavelength at peak emission	If=20mA	λ_p	--	630	--	nm
Spectral half bandwidth	If=20mA	$\Delta\lambda$	--	20	--	nm
Dominant wavelength	If=20mA	λ_d	620	--	630	nm
Forward voltage	If=20mA	Vf	1.8	--	2.4	V
Luminous intensity	If=20mA	Iv	1000	1500	--	mcd
Viewing angle at 50% Iv	If=10mA	2 θ 1/2	--	20	--	Deg
Reverse current	Vr=5V	Ir	--	--	10	μ A

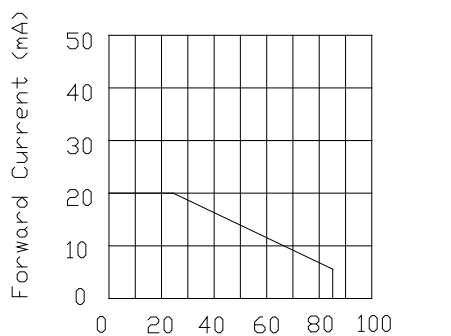
Optical Characteristic Curves



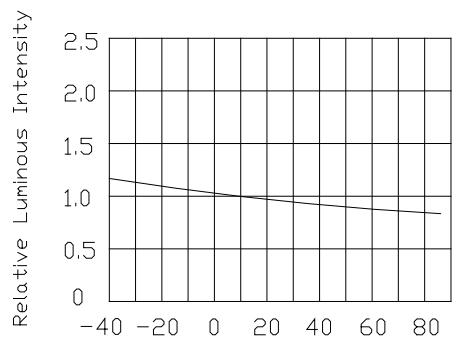
FORWARD CURRENT Vs.
FORWARD VOLTAGE



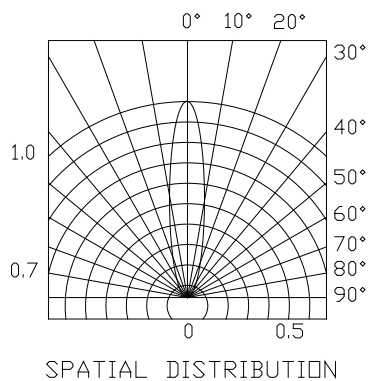
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

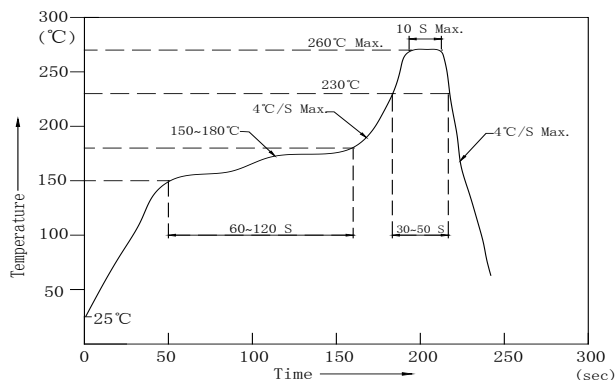


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



Reflow Profile

■ Reflow Temp/Time



Notes:

1. We recommend the reflow temperature 245°C ($\pm 5^\circ\text{C}$). the maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

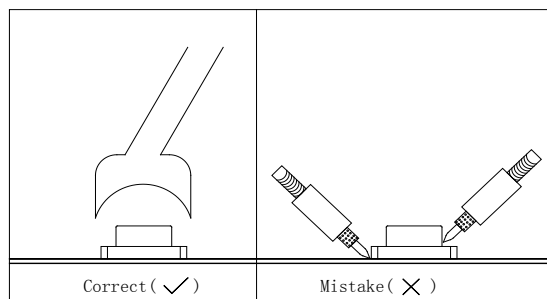
■ Soldering iron

Basic spec is $\leq 5\text{sec}$ when 320°C ($\pm 20^\circ\text{C}$). If temperature is higher, time should be shorter ($+10^\circ\text{C} \rightarrow -1\text{sec}$).

Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under 350°C .

■ Rework

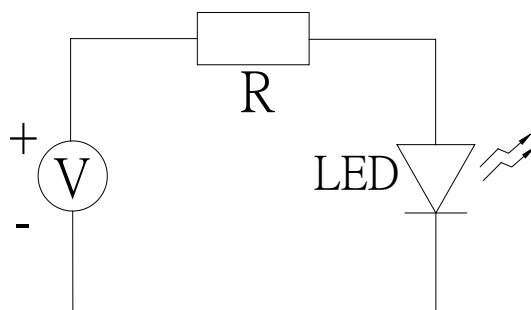
1. Customer must finish rework within 5 sec under 340°C .
2. The head of iron cannot touch copper foil
3. Twin-head type is preferred.



- Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

Test circuit and handling precautions

■ Test circuit



■ Handling precautions

1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change
(Burn out will happen).

2. Storage

2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: 5°C~30°C

2.2 Shelf life in sealed bag: 12 month at <5°C~30°C and <30% R.H. after the package is opened, the products should be used within a week or they should be keeping to stored at ≤ 20 R.H. with zip-lock sealed.

3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

3.1 60±3°C x (12~24hrs) and <5%RH, taped reel type

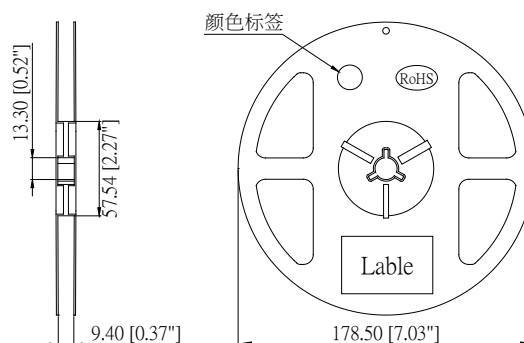
3.2 100±3°C x (45min~1hr), bulk type

3.3 130±3°C x (15~30min), bulk type

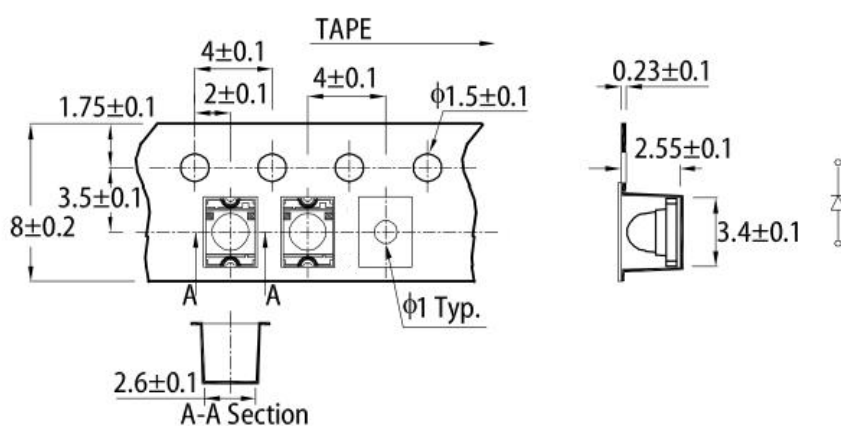
Test Items and Results of Reliability

Test Item	Test Conditions	Standard Test Method	Note	Number of Test
Reflow Soldering	Ta=260±5℃,Time=10±2S	JB/T 10845-2008	3times	0/22
Salt Atmosphere	Ta=35±3℃,PH=6.5~7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5℃ 30±1min ↑→(25℃/5±1min)↓ 100±5℃ 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=-40±5℃~100±5℃, 15±1min dwell	GB/T 2423.22-2012	100cycles	0/22
High Humidity High Temp. Cycling	Ta=30±5℃~65±5℃, 90±5%RH,24hrs/1cycle	GB/T 2423.4-2008	10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5℃,ψ(%)=85±5%RH	GB/T 2423.3-2006	1000hrs	0/22
High Temperature Storage Life	Ta=100±5℃,non-operating	GB/T 2423.2-2008	1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5℃,non-operating	GB/T 2423.1-2008	1000hrs	0/22
Life Test	Ta=26±5℃,@20mA, ψ(%)=25%RH~55%RH	--	1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5℃,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5℃,@20mA	GB/T 2423.1-2008	1000hrs	0/22

- **Dimensions of Reel (Unit: mm)**



- **Dimensions of Tape (Unit: mm)**



- **Arrangement of Tape**

